# PNZ323B (PN323B)

### Silicon planar type

#### For optical control systems

#### Features

- Fast response which is well suited to high speed modulated light detection:  $t_r$ ,  $t_f = 50$  ns (typ.)
- High sensitivity, high reliability
- Peak sensitivity wavelength matched with infrared light emitting diodes:  $\lambda_{PD} = 970$  nm (typ.)
- Wide detection area, wide half-power angle:  $\theta = 70^{\circ}$  (typ.)
- Adoption of visible light cutoff resin

#### Absolute Maximum Ratings $T_a = 25^{\circ}C$

Parameter	Symbol	Rating	Unit	
Reverse voltage	V <sub>R</sub>	30	V	
Power dissipation	P <sub>D</sub>	100	mW	
Operating ambient temperature	T <sub>opr</sub>	-30 to +85	°C	
Storage temperature	T <sub>stg</sub>	-40 to +100	°C	

#### Electrical-Optical Characteristics $T_a = 25^{\circ}C \pm 3^{\circ}C$

Parameter	Symbol	Conditions	Min	Тур	Max	Unit
Sensitivity to infrared radiation *1	S <sub>IR</sub>	$V_{\rm R} = 5 \text{ V}, \text{H} = 0.1 \text{ mW/cm}^2$	3.2	4	00	μΑ
Photocurrent *2	IL	$V_{\rm R} = 10 \text{ V}, \text{L} = 1000 \text{ lx}$	2	. 31	0.0	μΑ
Drain current	I <sub>D</sub>	$V_R = 10 V$	8 .0	5	50	nA
Terminal capacitance	Ct	$V_R = 0 V, f = 1 MHz$	K Jon	70		pF
Peak sensitivity wavelength	$\lambda_{PD}$	$V_R = 10 V$	22 60	970		nm
Half-power angle	ece	The angle when the sensitivity to infrared radiation is halved	OSI ON	70		o
Rise time *3	t <sub>r</sub>			50		ns
Fall time *3	t <sub>f</sub>	$V_R = 10 V, R_L = 1 k\Omega$		50		ns
Rise time *3	t <sub>r</sub>	V 10V D 10010		5		μs
Fall time *3	t <sub>f</sub>	$V_{\rm R} = 10 \text{ V}, \text{ R}_{\rm L} = 100 \text{ k}\Omega$		5		μs

Note) 1. Measuring methods are based on JAPANESE INDUSTRIAL STANDARD JIS C 7031 measuring methods for diodes.

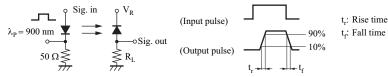
2. Spectral sensitivity characteristics: Sensitivity for wave length over 400 nm maximum sensitivity ratio is 100%.

3. This device is designed by disregarding radiation.

4. \*1:Source: Infrared emitters ( $\lambda = 940 \text{ nm}$ )

\*2: Source: Tungsten lamp (color temperature 2 856K)

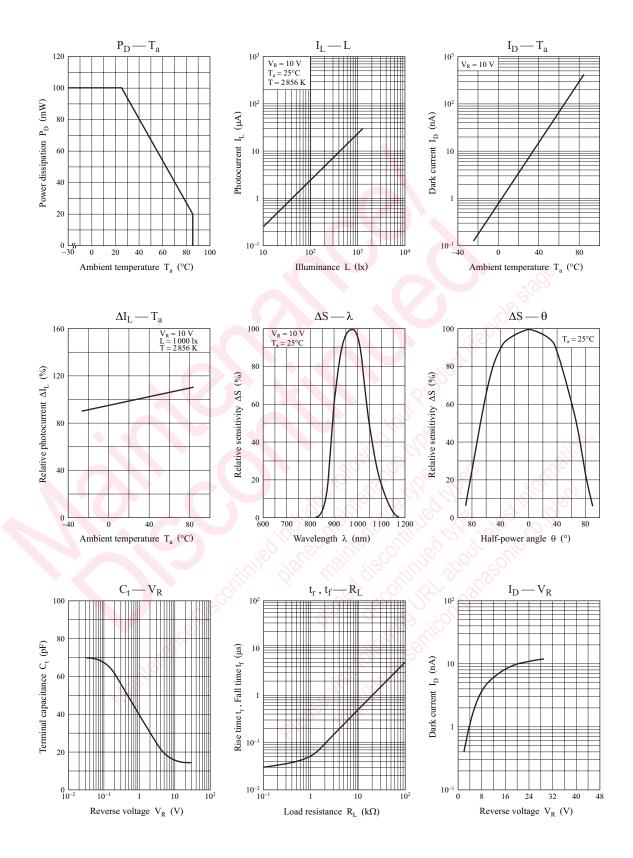
\*3: Switching time measurement circuit



Note) The part number in the parenthesis shows conventional part number.

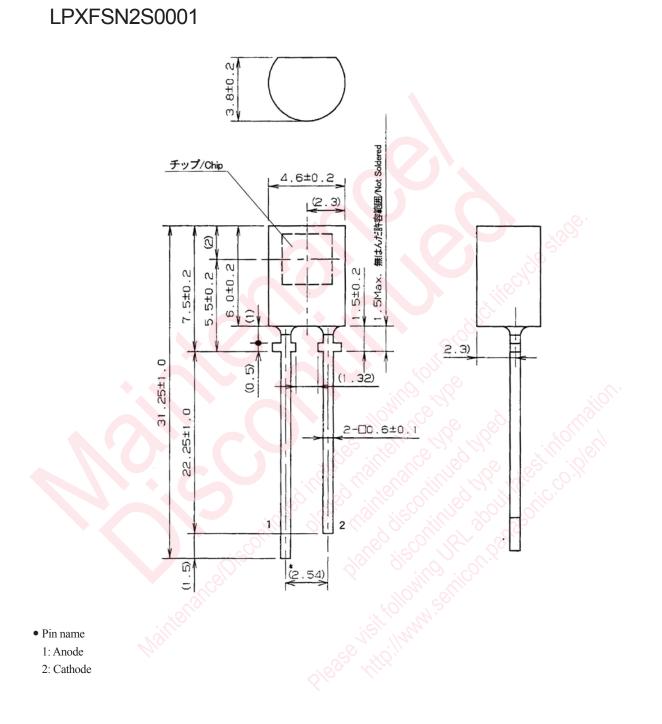
#### PNZ323B

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Package (Unit: mm)



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